

CBR04C389B3GAC

CBR-SMD RF COG, Ceramic, 3.8 pF, +/-0.1 pF, 25 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0402



Click here for the 3D model.

Dimensions		
Chip Size	0402	
L	1mm +/-0.05mm	
W	0.5mm +/-0.05mm	
Т	0.5mm +/-0.05mm	
В	0.25mm +0.05/-0.1mm	

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	10000

General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	1.4 mg
Notes	Solder Reflow Only.
Shelf Life	78 Weeks
MSL	1

3.8 pF
+/-0.1pF
25 VDC
62.5 VDC
-55/+125°C
COG
0.21%
0% Loss/Decade Hour
10 GOhms
476

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